



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP15022	REV: E1	SVN REV: Not In VersionControl
	TID #: PMP15022		
PLOT NAME = Top Assembly Drawing	GENERATED : 1/30/2017 8:10:54 AM		TEXAS INSTRUMENTS

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